Introduction

Thank you for participating in the Virtex-7 FPGAs Engineering Sample Program. As part of this program, we are pleased to provide to you engineering samples of the devices listed in Table 1. Although Xilinx has made every effort to ensure the highest possible quality, these devices are subject to the limitations described in the following errata.

Devices

These errata apply to the devices shown in Table 1.

Table 1: Devices Affected by These Errata

<table>
<thead>
<tr>
<th>Product Family</th>
<th>Device</th>
<th>JTAG ID (Revision Code)</th>
<th>Packages</th>
<th>Speed Grades</th>
</tr>
</thead>
<tbody>
<tr>
<td>Virtex-7</td>
<td>XC7VX1140T CES9937</td>
<td>0</td>
<td>All</td>
<td>-1, -2</td>
</tr>
</tbody>
</table>

Hardware Errata Details

This section provides a detailed description of each hardware issue known at the release time of this document.

GTH Transceivers

**TX Interface Widths for 64B/66B or 64B/67B with GEARBOX_MODE[2] = 1'b1**

When 64B/66B or 64B/67B Encoding with GEARBOX_MODE[2] = 1'b1 (CAUI Interface mode) is used, the 4-byte FPGA TX interface with 4-byte internal data width (TX_DATA_WIDTH = 32 and TX_INT_DATAWIDTH = 1) must be used. The 8-byte FPGA TX interface with 4-byte internal data width (TX_DATA_WIDTH = 64 and TX_INT_DATAWIDTH = 1) is not supported.

When 64B/66B or 64B/67B Encoding with GEARBOX_MODE[2] = 1'b1 (CAUI Interface mode) is used with 4-byte internal data width (RX_DATA_WIDTH = 64/32 and RX_INT_DATAWIDTH = 1), both the 8-byte and 4-byte FPGA RX interfaces are supported.

**GTH Transceiver Power-On/Power-Off**

If the recommended sequence is followed, while \( V_{MGTA\text{VCC}} \) is powered within its recommended operating range and \( V_{MGTA\text{VTT}} \) is below 0.7V, an additional 70 mA per transceiver is drawn from \( V_{MGTA\text{VCC}} \).

Depending on the number of transceivers used, this extra current can be greater than the consumption reported in XPE.

Refer to Answer Record 47443 for more information.

**GTH Transceiver Eye Scan**

To use the GTH receiver eye scan, RX_DATA_WIDTH must be set to 16, 32, or 64. Refer to Answer Record 47128 for more information.
**GTH Transceiver Link Margin Reduction**

For GTH transceiver line rates up to 8.5 Gb/s, there can be up to a 0.05 UI increase in transmitter output jitter and up to a 0.05 UI decrease in receiver input jitter tolerance when multiple channels are used.

For GTH transceiver line rates higher than 8.5 Gb/s, there can be up to a 0.1 UI increase in transmitter output jitter and up to a 0.1 UI decrease in receiver input jitter tolerance when multiple channels are used.

See [Answer Record 47128](www.xilinx.com) for additional information.

**RXOUTCLK Port**

For GTH transceiver line rates higher than 8.5 Gb/s, the GTH transceiver RXOUTCLK port, when configured to use the RXOUTCLKPCS or RXOUTCLKPMA path, can exhibit a phase jump of up to 2 UI of the line rate. In buffer bypass mode, the RXOUTCLK port cannot be used. For buffer use mode, see [Answer Record 47128](www.xilinx.com) for additional information.

**PCle**

**Virtual Channel Capability**

The Virtual Channel Capability is always enabled in Configuration Space when the Secondary PCI Express® Capability is enabled.

**Virtual Channel TC/VC Map**

The Virtual Channel Resource Control register TC/VC Map is incorrectly reset to $8'h01$ instead of the PCIe Base Specification 3.0 value of $8'hFF$.

**Loopback Exit**

Reset of the LTSSM state machine is required to exit Loopback.Active state in loopback slave mode at Gen3 link speed.

**Power Budgeting Capability**

The Power Budgeting Capability is not supported.

**Resizable BAR**

The optional PCIe Resizable BAR (RBAR) capability is not supported through configuration. The RBAR feature can be initiated after the FPGA has been configured.

**End-to-End CRC**

When End-to-End CRC (ECRC) is used with multiple functions (PF0 and PF1 enabled), then ECRC must be enabled for either both functions or neither. It cannot be enabled independently on a per function basis. If only PF0 is used, then ECRC can be enabled or disabled as required.

**TLP Processing Hints**

The TLP Processing Hints (TPH) Completer is not supported.

**D1 Power State**

The D1 lower power device state is not supported.

**Root Port**

Root Port mode is not supported.
**AER Header Log Overflow**

For the Virtual Function Configuration Space, the optional AER Correctable Error Status register Header Log Overflow Status bit is not supported.

**Function Level Reset**

Function Level Reset (FLR) of SR-IOV Physical Functions is not supported. The ARI Capable Hierarchy bit in the Physical Function SR-IOV Control register is reset by a Function Level Reset of the Physical Function.

**Requester reQuest (RQ) Sequence Number**

The output ports pcie_rq_seq_num[3:0], pcie_rq_seq_num_vld in the Requester reQuest (RQ) interface and seq_num[3:0] inputs within the s_axis_rq_tuser bus are not supported. As a result, the optional method for transmit transaction ordering control is not supported.

**Power**

**Static Power**

All power supplies can exhibit up to 50% higher static current compared to the static current reported in the Xilinx Power Estimator (XPE) 14.1 (or later). Also, up to an additional 50 mA per powered transceiver Quad can be consumed by the $V_{MGTA}VCC$ supply.

**Packaging**

**Package Assembly**

Bake units for 4 hours at 125°C before assembly. Within 30 minutes of taking the units from the bake oven, assemble them on the final system board. Failure to follow this baking procedure can result in device damage during assembly.

**Design Tool Requirements**

The devices listed in Table 1, unless otherwise specified, require the following Xilinx Design Tools:

- For GTH transceiver attribute updates, refer to Answer Record 47128.
- See Virtex-7 FPGA Answer Record 47476 for the most current known issues and work-arounds for Xilinx Design Tools.
Operational Guidelines

Hardware Validation for Memory Interfaces

The memory interfaces listed in Table 2 have been validated in hardware across the operating conditions for these devices at the time of publication. See Answer Record 46521 for the latest hardware validation information.

Table 2: Hardware Validated Memory Interfaces

<table>
<thead>
<tr>
<th>Type</th>
<th>Condition</th>
<th>Bank</th>
</tr>
</thead>
<tbody>
<tr>
<td>DDR3</td>
<td>DIMM and Component Single Rank</td>
<td>HP</td>
</tr>
<tr>
<td>QDRII+</td>
<td>Component Single Rank</td>
<td>HP</td>
</tr>
<tr>
<td>RLDRAMII</td>
<td>Component Single Rank</td>
<td>HP</td>
</tr>
<tr>
<td>DDR2</td>
<td>DIMM and Component Single Rank</td>
<td>HP</td>
</tr>
</tbody>
</table>

Traceability

Figure 1 shows an example device top mark for the devices listed in Table 1.

Additional Questions or Clarifications

For additional questions regarding these errata, contact Xilinx Technical Support: http://www.xilinx.com/support/clearexpress/websupport.htm or your Xilinx Sales Representative: http://www.xilinx.com/company/contact/index.htm.
Revision History

The following table shows the revision history for this document:

<table>
<thead>
<tr>
<th>Date</th>
<th>Version</th>
<th>Description of Revisions</th>
</tr>
</thead>
<tbody>
<tr>
<td>07/20/12</td>
<td>1.0</td>
<td>Initial Xilinx release.</td>
</tr>
<tr>
<td>12/06/12</td>
<td>1.1</td>
<td>Added TX Interface Widths for 64B/66B or 64B/67B with GEARBOX_MODE[2] = 1'b1. Removed the recommended sequence from GTH Transceiver Power-On/Power-Off because the specifications were added to DS183, Virtex-7 T and XT FPGAs Data Sheet: DC and Switching Characteristics (v1.5) August 3, 2012. Updated GTH Transceiver Link Margin Reduction to change units from percentage to UI. Removed MGTAVCC Voltage Requirement errata because the requirement was added to DS183, Virtex-7 T and XT FPGAs Data Sheet: DC and Switching Characteristics (v1.5) August 3, 2012. Updated Root Port. Added Requester reQuest (RQ) Sequence Number. Removed Configuration Fallback because the SPI 32-bit addressing mode support exception was added to UG470, 7 Series FPGAs Configuration User Guide (v1.4) July 19, 2012.</td>
</tr>
<tr>
<td>02/15/13</td>
<td>1.2</td>
<td>Removed Package Coplanarity because the specifications were updated in UG475, 7 Series FPGAs Packaging and Pinout Specification (v1.8) October 15, 2012. Updated Static Power, Design Tool Requirements.</td>
</tr>
</tbody>
</table>

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